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"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	RXv2
Core Size	32-Bit Single-Core
Speed	120MHz
Connectivity	CANbus, EBI/EMI, Ethernet, I²C, LINbus, MMC/SD, SCI, SPI, SSI, UART/USART, USB
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	111
Program Memory Size	2.5MB (2.5M x 8)
Program Memory Type	FLASH
EEPROM Size	64K x 8
RAM Size	552K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V
Data Converters	A/D 29x12b; D/A 2x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	144-LQFP
Supplier Device Package	144-LFQFP (20x20)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f564mggdfb-v1

Table 1.1 Outline of Specifications (2/9)

Classification	Module/Function	Description
Clock	Clock generation circuit	• Main clock oscillator, sub clock oscillator, low-speed/high-speed on-chip oscillator, PLL frequency synthesizer, and IWDT-dedicated on-chip oscillator • The peripheral module clocks can be set to frequencies above that of the system clock. • Main-clock oscillation stoppage detection • Separate frequency-division and multiplication settings for the system clock (ICLK), peripheral module clocks (PCLKA, PCLKB, PCLKC, PCLKD), flash-IF clock (FCLK) and external bus clock (BCLK) The CPU and other bus masters run in synchronization with the system clock (ICLK): Up to 120 MHz Peripheral modules of MTU3, GPT, RSPI, SCIFA, USBA, ETHERC, EPTPC, EDMAC, and AES run in synchronization with PCLKA, which operates at up to 120 MHz. Other peripheral modules run in synchronization with PCLKB: Up to 60 MHz ADCLK in the SD12AD (unit 0) runs in synchronization with PCLKC: Up to 60 MHz ADCLK in the SD12AD (unit 1) runs in synchronization with PCLKD: Up to 60 MHz Flash IF run in synchronization with the flash-IF clock (FCLK): Up to 60 MHz Devices connected to the external bus run in synchronization with the external bus clock (BCLK): Up to 60 MHz • Multiplication is possible with using the high-speed on-chip oscillator (HOCO) as a reference clock of the PLL circuit
Reset		Nine types of reset • RES# pin reset: Generated when the RES# pin is driven low. • Power-on reset: Generated when the RES# pin is driven high and VCC = AVCC0 = AVCC1 rises. • Voltage-monitoring 0 reset: Generated when VCC = AVCC0 = AVCC1 falls. • Voltage-monitoring 1 reset: Generated when VCC = AVCC0 = AVCC1 falls. • Voltage-monitoring 2 reset: Generated when VCC = AVCC0 = AVCC1 falls. • Deep software standby reset: Generated in response to an interrupt to trigger release from deep software standby. • Independent watchdog timer reset: Generated when the independent watchdog timer underflows, or a refresh error occurs. • Watchdog timer reset: Generated when the watchdog timer underflows, or a refresh error occurs. • Software reset: Generated by register setting.
Power-on reset		If the RES# pin is at the high level when power is supplied, an internal reset is generated. After VCC = AVCC0 = AVCC1 has exceeded the voltage detection level and the specified period has elapsed, the reset is cancelled.
Voltage detection circuit (LVDA)		Monitors the voltage being input to the VCC = AVCC0 = AVCC1 pins and generates an internal reset or internal interrupt. • Voltage detection circuit 0 Capable of generating an internal reset The option-setting memory can be used to select enabling or disabling of the reset. Voltage detection level: Selectable from three different levels (2.94 V, 2.87 V, and 2.80 V) • Voltage detection circuits 1 and 2 Voltage detection level: Selectable from three different levels (2.99 V, 2.92 V, and 2.85 V) Digital filtering (1/2, 1/4, 1/8, and 1/16 LOCO frequency) Capable of generating an internal reset • Two types of timing are selectable for release from reset An internal interrupt can be requested. • Detection of voltage rising above and falling below thresholds is selectable. • Maskable or non-maskable interrupt is selectable Voltage detection monitoring Event linking
Low power consumption	Low power consumption facilities	• Module stop function • Four low power consumption modes Sleep mode, all-module clock stop mode, software standby mode, and deep software standby mode
	Battery backup function	• When the voltage on the VCC pin drops, battery power from the VBATT pin is supplied to keep the real-time clock (RTC) operating.

Table 1.6 List of Pin and Pin Functions (176-Pin LFQFP) (2/7)

Pin Number 176-Pin LFQFP	Power Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	Timer (MTU, GPT, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	Communication (ETHERC, SCIg, SCIh, RSPI, RIIC, CAN, USB, SSI)	Memory Interface Camera Interface (QSPI, SDHI, MMCIF, PDC)	Interrupt	S12ADC, R12DA
36		P27	CS7#	MTIOC2B/TMCI3/PO7	SCK1/ET1_WOL			
37		P26	CS6#	MTIOC2A/TMO1/PO6	TXD1/CTS3#/ RTS3#/SMOSI1/ SS3#/SSDA1/ ET1_EXOUT			
38		P25	CS5#/ EDACK1	MTIOC4C/MTCLKB/ TIOCA4/PO5	RXD3/SMISO3/ SSCL3/ SSIDATA1	HSYNC		ADTRG0#
39	VCC							
40		P24	CS4#/ EDREQ1	MTIOC4A/MTCLKA/ TIOCB4/TMRI1/PO4	SCK3/ USB0_VBUSEN/ SSISCK1	PIXCLK		
41	VSS							
42		P23	EDACK0	MTIOC3D/MTCLKD/ GTIOC0A-B/TIOCD3/ PO3	TXD3/CTS0#/ RTS0#/SMOSI3/ SS0#/SSDA3/ SSISCK0	PIXD7		
43		P22	EDREQ0	MTIOC3B/MTCLKC/ GTIOC1A-B/TIOCC3/ TMO0/PO2	SCK0/ USB0_OVRCURB/ USBA_OVRCURB/ AUDIO_MCLK	PIXD6		
44		P21		MTIOC1B/MTIOC4A/ GTIOC2A-B/TIOCA3/ TMCI0/PO1	RXD0/SMISO0/ SSCL0/ USB0_EXICEN/ USBA_EXICEN/ SSIWS0	PIXD5	IRQ9	
45		P20		MTIOC1A/TIOCB3/ TMRI0/PO0	TXD0/SMOSI0/ SSDA0/USB0_ID/ USBA_ID/ SSIRXD0	PIXD4	IRQ8	
46		P17		MTIOC3A/MTIOC3B/ MTIOC4B/ GTIOC0B-B/TIOCB0/ TCLKD/TMO1/PO15/ POE8#	SCK1/TXD3/ SMOSI3/SSDA3/ SDA2-DS/ SSITXD0	PIXD3	IRQ7	ADTRG1#
47		P87		MTIOC4C/ GTIOC1B-B/TIOCA2	TXD10	PIXD2		
48		P16		MTIOC3C/MTIOC3D/ TIOCB1/TCLKC/ TMO2/PO14/ RTCOUT	TXD1/RXD3/ SMOSI1/SMISO3/ SSDA1/SSCL3/ SCL2-DS/ USB0_VBUS/ USB0_VBUSEN/ USB0_OVRCURB		IRQ6	ADTRG0#
49		P86		MTIOC4D/ GTIOC2B-B/TIOCA0	RXD10	PIXD1		
50		P15		MTIOC0B/MTCLKB/ GTETRG-B/TIOCB2/ TCLKB/TMCI2/PO13	RXD1/SCK3/ SMISO1/SSCL1/ CRX1-DS/ USBA_VBUSEN/ SSIWS1	PIXD0	IRQ5	
51		P14		MTIOC3A/MTCLKA/ TIOCB5/TCLKA/ TMRI2/PO15	CTS1#/RTS1#/ SS1#/CTX1/ USB0_OVRCURA		IRQ4	
52		P13	WR2#/BC2#	MTIOC0B/TIOCA5/ TMO3/PO13	TXD2/SMOSI2/ SSDA2/ SDA0[FM+]		IRQ3	ADTRG1#
53		P12	WR3#/BC3#	MTIC5U/TMCI1	RXD2/SMISO2/ SSCL2/ SCL0[FM+]		IRQ2	
54	VCC_USB							
55					USB0_DM			
56					USB0_DP			

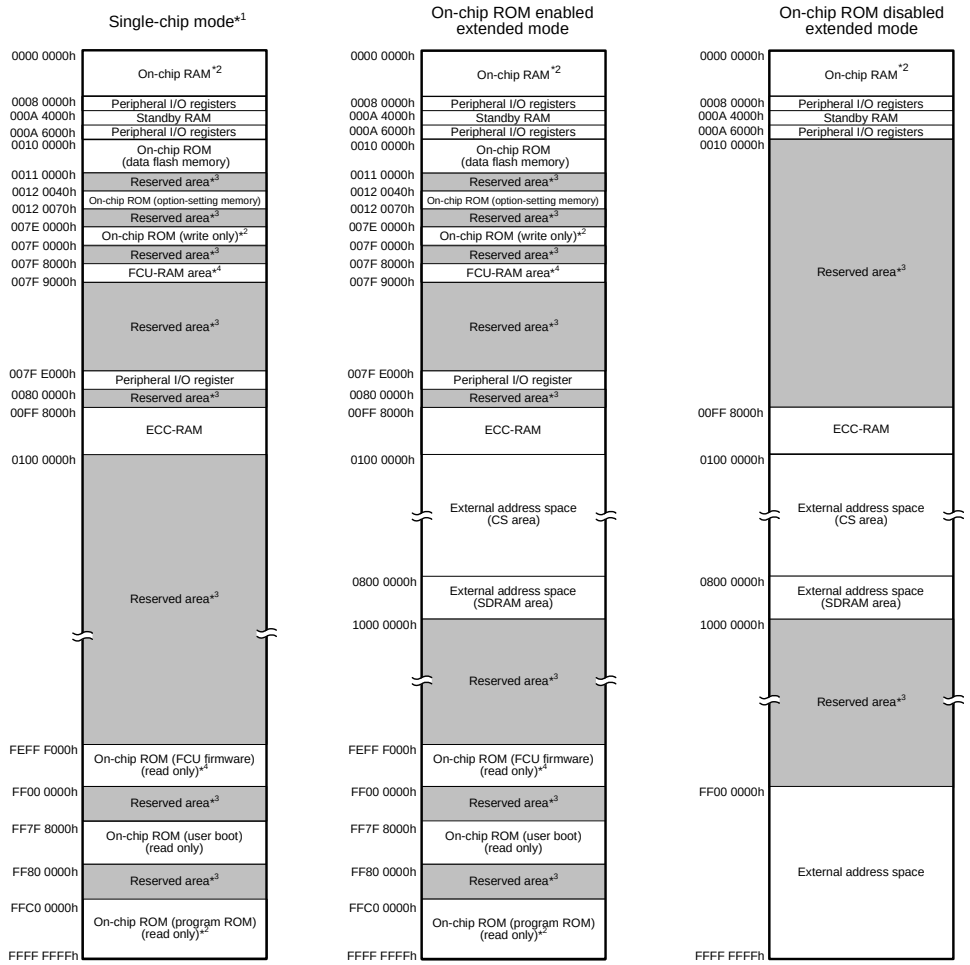
Table 1.7 List of Pin and Pin Functions (145-Pin TFLGA) (4/5)

Pin Number 145-Pin TFLGA	Power Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	Timer (MTU, GPT, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	Communication (ETHERC, SCIg, SCIh, RSPI, RIIC, CAN, USB, SSI)	Memory Interface Camera Interface (QSPI, SDHI, MMCIF, PDC)	Interrupt	S12ADC, R12DA
K5	TRDATA2	P54	ALE/EDACK0	MTIOC4B/TMCI1	CTS2#/RTS2#/SS2#/ CTX1/ET0_LINKSTA			
K6		P53*1	BCLK					
K7		P51	WR1#/BC1#/ WAIT#		SCK2			
K8	VCC							
K9	TRDATA0	P80	EDREQ0	MTIOC3B/PO26	SCK10/RTS10#/ ET0_TX_EN/ RMII0_TXD_EN	MMC_D2-A/ SDHI_WP-A/ QIO2-A		
K10		P76	CS6#	PO22	RXD11/ET0_RX_CLK/ REF50CK0	MMC_CMD-A/ SDHI_CMD-A/ QSSL-A		
K11		PB7	A15	MTIOC3B/TIOCB5/ PO31	TXD9/ET0_CRS/ RMII0_CRS_DV			
K12		PB6	A14	MTIOC3D/TIOCA5/ PO30	RXD9/ET0_ETXD1/ RMII0_TXD1			
K13		PB5	A13	MTIOC2A/MTIOC1B/ TIOCB4/TMRI1/PO29/ POE4#	SCK9/RTS9#/ ET0_ETXD0/ RMII0_TXD0			
L1		P25	CS5#/ EDACK1	MTIOC4C/MTCLKB/ TIOCA4/PO5	RXD3/SMISO3/ SSCL3/SSIDATA1	HSYNC		ADTRG0#
L2		P23	EDACK0	MTIOC3D/MTCLKD/ GTIOC0A-B/TIOCD3/ PO3	TXD3/CTS0#/RTS0#/ SMOSI3/SS0#/ SSDA3/SSISCK0	PIXD7		
L3		P16		MTIOC3C/MTIOC3D/ TIOCB1/TCLKC/ TMO2/PO14/ RTCOUT	TXD1/RXD3/SMOSI1/ SMISO3/SSDA1/ SSCL3/SCL2-DS/ USB0_VBUS/ USB0_VBUSEN/ USB0_OVRCURB		IRQ6	ADTRG0#
L4		P24	CS4#/ EDREQ1	MTIOC4A/MTCLKA/ TIOCB4/TMRI1/PO4	SCK3/ USB0_VBUSEN/ SSISCK1	PIXCLK		
L5		P13		MTIOC0B/TIOCA5/ TMO3/PO13	TXD2/SMOSI2/ SSDA2/SDA0[FM+]		IRQ3	ADTRG1#
L6		P56	EDACK1	MTIOC3C/TIOCA1				
L7		P52	RD#		RXD2/SMISO2/SSCL2			
L8	TRCLK	P83	EDACK1	MTIOC4C/ GTIOC0A-D	CTS10#/ET0_CRS/ RMII0_CRS_DV/ SCK10			
L9		PC5	A21/CS2#/ WAIT#	MTIOC3B/MTCLKD/ GTIOC1A-D/TMRI2/ PO29	SCK8/RSPCKA-A/ RTS8#/ET0_ETXD2	MMC_D5-A		
L10		PC4	A20/CS3#	MTIOC3D/MTCLKC/ GTETRG-D/TMCI1/ PO25/POE0#	SCK5/CTS8#/ SSLA0-A/ ET0_TX_CLK	MMC_D1-A/ SDHI_D1-A/ QIO1-A/QMI-A		
L11		PC2	A18	MTIOC4B/ GTIOC2B-D/TCLKA/ PO21	RXD5/SMISO5/ SSCL5/SSLA3-A/ ET0_RX_DV	MMC_CD-A/ SDHI_D3-A		
L12		P73	CS3#	PO16	ET0_WOL			
L13	VSS							
M1		P22	EDREQ0	MTIOC3B/MTCLKC/ GTIOC1A-B/TIOCC3/ TMO0/PO2	SCK0/ USB0_OVRCURB/ AUDIO_MCLK	PIXD6		
M2		P17		MTIOC3A/MTIOC3B/ MTIOC4B/ GTIOC0B-B/TIOCB0/ TCLKD/TMO1/PO15/ POE8#	SCK1/TXD3/SMOSI3/ SSDA3/SDA2-DS/ SSITXD0	PIXD3	IRQ7	ADTRG1#
M3		P86		MTIOC4D/ GTIOC2B-B/TIOCA0	RXD10	PIXD1		

3. Address Space

3.1 Address Space

This MCU has a 4-Gbyte address space, consisting of the range of addresses from 0000 0000h to FFFF FFFFh. That is, linear access to an address space of up to 4 Gbytes is possible, and this contains both program and data areas.
Figure 3.1 shows the memory maps in the respective operating modes. Accessible areas will differ according to the operating mode and states of control bits.



Note 1. The address space in boot mode and user boot mode/USB boot mode is the same as the address space in single-chip mode.
Note 2. The capacity of ROM/RAM differs depending on the products.

Code Flash Memory Capacity	Address	Data Flash Memory Capacity	Address	RAM Capacity	Address
4 Mbytes	FFC0 0000h to FFFF FFFFh	64 Kbytes	0010 0000h to 0010 FFFFh	512 Kbytes	0000 0000h to 0007 FFFFh
3 Mbytes	FFD0 0000h to FFFF FFFFh				
2.5 Mbytes	FFD8 0000h to FFFF FFFFh				
2 Mbytes	FFE0 0000h to FFFF FFFFh				

Note 3. Reserved areas should not be accessed.
Note 4. The FCU-RAM and the on-chip ROM (FCU firmware) are reserved in products that do not include the FCU-RAM. For details on the FCU, see section 63, Flash Memory, in the RX64M Group User's Manual: Hardware.

Figure 3.1 Memory Map in Each Operating Mode

4.1 I/O Register Addresses (Address Order)

Table 4.1 List of I/O Registers (Address Order) (1 / 67)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access Cycles		Related Function
						ICLK ≥ PCLK	ICLK < PCLK	
0008 0000h	SYSTEM	Mode Monitor Register	MDMONR	16	16	3 ICLK		Operating Modes
0008 0002h	SYSTEM	Mode Status Register	MDSR	16	16	3 ICLK		Operating Modes
0008 0006h	SYSTEM	System Control Register 0	SYSCR0	16	16	3 ICLK		Operating Modes
0008 0008h	SYSTEM	System Control Register 1	SYSCR1	16	16	3 ICLK		Operating Modes
0008 000Ch	SYSTEM	Standby Control Register	SBYCR	16	16	3 ICLK		Low Power Consumption
0008 0010h	SYSTEM	Module Stop Control Register A	MSTPCRA	32	32	3 ICLK		Low Power Consumption
0008 0014h	SYSTEM	Module Stop Control Register B	MSTPCRB	32	32	3 ICLK		Low Power Consumption
0008 0018h	SYSTEM	Module Stop Control Register C	MSTPCRC	32	32	3 ICLK		Low Power Consumption
0008 001Ch	SYSTEM	Module Stop Control Register D	MSTPCRD	32	32	3 ICLK		Low Power Consumption
0008 0020h	SYSTEM	System Clock Control Register	SCKCR	32	32	3 ICLK		Clock Generation Circuit
0008 0024h	SYSTEM	System Clock Control Register 2	SCKCR2	16	16	3 ICLK		Clock Generation Circuit
0008 0026h	SYSTEM	System Clock Control Register 3	SCKCR3	16	16	3 ICLK		Clock Generation Circuit
0008 0028h	SYSTEM	PLL Control Register	PLLCR	16	16	3 ICLK		Clock Generation Circuit
0008 002Ah	SYSTEM	PLL Control Register 2	PLLCR2	8	8	3 ICLK		Clock Generation Circuit
0008 0030h	SYSTEM	External Bus Clock Control Register	BCKCR	8	8	3 ICLK		Clock Generation Circuit
0008 0032h	SYSTEM	Main Clock Oscillator Control Register	MOSCCR	8	8	3 ICLK		Clock Generation Circuit
0008 0033h	SYSTEM	Sub-Clock Oscillator Control Register	SOSCCR	8	8	3 ICLK		Clock Generation Circuit
0008 0034h	SYSTEM	Low-Speed On-Chip Oscillator Control Register	LOCOCR	8	8	3 ICLK		Clock Generation Circuit

Table 4.1 List of I/O Registers (Address Order) (18 / 67)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access Cycles		Related Function
						ICLK ≥ PCLK	ICLK < PCLK	
0008 857Ch	MMCIF	Version Register	CEVERSION	32	32	2, 3 PCLKB	2 ICLK	MMCIF
0008 9000h	S12AD	A/D Control Register	ADCSR	16	16	2, 3 PCLKB	2 ICLK	S12ADC
0008 9004h	S12AD	A/D Channel Select Register A0	ADANSA0	16	16	2, 3 PCLKB	2 ICLK	S12ADC
0008 9008h	S12AD	A/D-Converted Value Addition/Average Mode Select Register 0	ADADS0	16	16	2, 3 PCLKB	2 ICLK	S12ADC
0008 900Ch	S12AD	A/D-Converted Value Addition/Average Count Select Register	ADADC	8	8	2, 3 PCLKB	2 ICLK	S12ADC
0008 900Eh	S12AD	A/D Control Extended Register	ADCER	16	16	2, 3 PCLKB	2 ICLK	S12ADC
0008 9010h	S12AD	A/D Start Trigger Select Register	ADSTRGR	16	16	2, 3 PCLKB	2 ICLK	S12ADC
0008 9014h	S12AD	A/D Channel Select Register B0	ADANSB0	16	16	2, 3 PCLKB	2 ICLK	S12ADC
0008 9018h	S12AD	A/D Data Duplication Register	ADDBLDR	16	16	2, 3 PCLKB	2 ICLK	S12ADC
0008 901Eh	S12AD	A/D Self-Diagnosis Data Register	ADRD	16	16	2, 3 PCLKB	2 ICLK	S12ADC
0008 9020h	S12AD	A/D Data Register 0	ADDR0	16	16	2, 3 PCLKB	2 ICLK	S12ADC
0008 9022h	S12AD	A/D Data Register 1	ADDR1	16	16	2, 3 PCLKB	2 ICLK	S12ADC
0008 9024h	S12AD	A/D Data Register 2	ADDR2	16	16	2, 3 PCLKB	2 ICLK	S12ADC
0008 9026h	S12AD	A/D Data Register 3	ADDR3	16	16	2, 3 PCLKB	2 ICLK	S12ADC
0008 9028h	S12AD	A/D Data Register 4	ADDR4	16	16	2, 3 PCLKB	2 ICLK	S12ADC
0008 902Ah	S12AD	A/D Data Register 5	ADDR5	16	16	2, 3 PCLKB	2 ICLK	S12ADC
0008 902Ch	S12AD	A/D Data Register 6	ADDR6	16	16	2, 3 PCLKB	2 ICLK	S12ADC
0008 902Eh	S12AD	A/D Data Register 7	ADDR7	16	16	2, 3 PCLKB	2 ICLK	S12ADC
0008 9060h	S12AD	A/D Sampling State Register 0	ADSSTR0	8	8	2, 3 PCLKB	2 ICLK	S12ADC
0008 9066h	S12AD	A/D Sample-and-Hold Circuit Control Register	ADSHCR	16	16	2, 3 PCLKB	2 ICLK	S12ADC
0008 9073h	S12AD	A/D Sampling State Register 1	ADSSTR1	8	8	2, 3 PCLKB	2 ICLK	S12ADC
0008 9074h	S12AD	A/D Sampling State Register 2	ADSSTR2	8	8	2, 3 PCLKB	2 ICLK	S12ADC
0008 9075h	S12AD	A/D Sampling State Register 3	ADSSTR3	8	8	2, 3 PCLKB	2 ICLK	S12ADC
0008 9076h	S12AD	A/D Sampling State Register 4	ADSSTR4	8	8	2, 3 PCLKB	2 ICLK	S12ADC
0008 9077h	S12AD	A/D Sampling State Register 5	ADSSTR5	8	8	2, 3 PCLKB	2 ICLK	S12ADC
0008 9078h	S12AD	A/D Sampling State Register 6	ADSSTR6	8	8	2, 3 PCLKB	2 ICLK	S12ADC
0008 9079h	S12AD	A/D Sampling State Register 7	ADSSTR7	8	8	2, 3 PCLKB	2 ICLK	S12ADC
0008 907Ah	S12AD	A/D Disconnection Detection Control Register	ADDISCR	8	8	2, 3 PCLKB	2 ICLK	S12ADC
0008 907Ch	S12AD	A/D Sample-and-Hold Operating Mode Select Register	ADSHMSR	8	8	2, 3 PCLKB	2 ICLK	S12ADC
0008 9080h	S12AD	A/D Group Scan Priority Control Register	ADGSPCR	16	16	2, 3 PCLKB	2 ICLK	S12ADC
0008 9084h	S12AD	A/D Data Duplication Register A	ADDBLDRA	16	16	2, 3 PCLKB	2 ICLK	S12ADC
0008 9086h	S12AD	A/D Data Duplication Register B	ADDBLDRB	16	16	2, 3 PCLKB	2 ICLK	S12ADC

Table 4.1 List of I/O Registers (Address Order) (23 / 67)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access Cycles		Related Function
						ICLK ≥ PCLK	ICLK < PCLK	
0008 A030h	SCI1	Receive Data Register HL	RDRHL	16	16	4, 5 PCLKB	2 ICLK	SCIg, SCIh
0008 A032h	SCI1	Modulation Duty Register	MDDR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh
0008 A040h	SCI2	Serial Mode Register	SMR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh
0008 A041h	SCI2	Bit Rate Register	BRR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh
0008 A042h	SCI2	Serial Control Register	SCR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh
0008 A043h	SCI2	Transmit Data Register	TDR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh
0008 A044h	SCI2	Serial Status Register	SSR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh
0008 A045h	SCI2	Receive Data Register	RDR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh
0008 A046h	SMCI2	Smart Card Mode Register	SCMR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh
0008 A047h	SCI2	Serial Extended Mode Register	SEMR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh
0008 A048h	SCI2	Noise Filter Setting Register	SNFR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh
0008 A049h	SCI2	I^2C Mode Register 1	SIMR1	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh
0008 A04Ah	SCI2	I^2C Mode Register 2	SIMR2	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh
0008 A04Bh	SCI2	I^2C Mode Register 3	SIMR3	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh
0008 A04Ch	SCI2	I^2C Status Register	SISR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh
0008 A04Dh	SCI2	SPI Mode Register	SPMR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh
0008 A04Eh	SCI2	Transmit Data Register H	TDRH	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh
0008 A04Fh	SCI2	Transmit Data Register L	TDRL	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh
0008 A04Eh	SCI2	Transmit Data Register HL	TDRHL	16	16	4, 5 PCLKB	2 ICLK	SCIg, SCIh
0008 A050h	SCI2	Receive Data Register H	RDRH	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh
0008 A051h	SCI2	Receive Data Register L	RDRL	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh
0008 A050h	SCI2	Receive Data Register HL	RDRHL	16	16	4, 5 PCLKB	2 ICLK	SCIg, SCIh
0008 A052h	SCI2	Modulation Duty Register	MDDR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh
0008 A060h	SCI3	Serial Mode Register	SMR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh
0008 A061h	SCI3	Bit Rate Register	BRR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh
0008 A062h	SCI3	Serial Control Register	SCR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh
0008 A063h	SCI3	Transmit Data Register	TDR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh
0008 A064h	SCI3	Serial Status Register	SSR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh
0008 A065h	SCI3	Receive Data Register	RDR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh
0008 A066h	SMCI3	Smart Card Mode Register	SCMR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh
0008 A067h	SCI3	Serial Extended Mode Register	SEMR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh

Table 4.1 List of I/O Registers (Address Order) (54 / 67)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access Cycles		Related Function
						ICLK ≥ PCLK	ICLK < PCLK	
000C 21C2h	GPT1	General PWM Timer Output Protection Function Temporary Release Register	GTSOTR	16	16	4, 5 PCLKA	2, 3 ICLK	GPTA
000C 2200h	GPT2	General PWM Timer I/O Control Register	GTIOR	16	16	4, 5 PCLKA	2, 3 ICLK	GPTA
000C 2202h	GPT2	General PWM Timer Interrupt Output Setting Register	GTINTAD	16	16	4, 5 PCLKA	2, 3 ICLK	GPTA
000C 2204h	GPT2	General PWM Timer Control Register	GTCR	16	16	4, 5 PCLKA	2, 3 ICLK	GPTA
000C 2206h	GPT2	General PWM Timer Buffer Enable Register	GTBER	16	16	4, 5 PCLKA	2, 3 ICLK	GPTA
000C 2208h	GPT2	General PWM Timer Count Direction Register	GTUDC	16	16	4, 5 PCLKA	2, 3 ICLK	GPTA
000C 220Ah	GPT2	General PWM Timer Interrupt and A/D Converter Start Request Skipping Setting Register	GTITC	16	16	4, 5 PCLKA	2, 3 ICLK	GPTA
000C 220Ch	GPT2	General PWM Timer Status Register	GTST	16	16	4, 5 PCLKA	2, 3 ICLK	GPTA
000C 220Eh	GPT2	General PWM Timer Counter	GTCNT	16	16	4, 5 PCLKA	2, 3 ICLK	GPTA
000C 2210h	GPT2	General PWM Timer Compare Capture Register A	GTCCRA	16	16	4, 5 PCLKA	2, 3 ICLK	GPTA
000C 2212h	GPT2	General PWM Timer Compare Capture Register B	GTCCRB	16	16	4, 5 PCLKA	2, 3 ICLK	GPTA
000C 2214h	GPT2	General PWM Timer Compare Capture Register C	GTCCRC	16	16	4, 5 PCLKA	2, 3 ICLK	GPTA
000C 2216h	GPT2	General PWM Timer Compare Capture Register D	GTCCRD	16	16	4, 5 PCLKA	2, 3 ICLK	GPTA
000C 2218h	GPT2	General PWM Timer Compare Capture Register E	GTCCRE	16	16	4, 5 PCLKA	2, 3 ICLK	GPTA
000C 221Ah	GPT2	General PWM Timer Compare Capture Register F	GTCCRF	16	16	4, 5 PCLKA	2, 3 ICLK	GPTA
000C 221Ch	GPT2	General PWM Timer Cycle Setting Register	GTPR	16	16	4, 5 PCLKA	2, 3 ICLK	GPTA
000C 221Eh	GPT2	General PWM Timer Cycle Setting Buffer Register	GTPBR	16	16	4, 5 PCLKA	2, 3 ICLK	GPTA
000C 2220h	GPT2	General PWM Timer Cycle Setting Double-Buffer Register	GTPDBR	16	16	4, 5 PCLKA	2, 3 ICLK	GPTA
000C 2224h	GPT2	A/D Converter Start Request Timing Register A	GTADTRA	16	16	4, 5 PCLKA	2, 3 ICLK	GPTA
000C 2226h	GPT2	A/D Converter Start Request Timing Buffer Register A	GTADTBRA	16	16	4, 5 PCLKA	2, 3 ICLK	GPTA
000C 2228h	GPT2	A/D Converter Start Request Timing Double-Buffer Register A	GTADTDBRA	16	16	4, 5 PCLKA	2, 3 ICLK	GPTA
000C 222Ch	GPT2	A/D Converter Start Request Timing Register B	GTADTRB	16	16	4, 5 PCLKA	2, 3 ICLK	GPTA
000C 222Eh	GPT2	A/D Converter Start Request Timing Buffer Register B	GTADTBRB	16	16	4, 5 PCLKA	2, 3 ICLK	GPTA
000C 2230h	GPT2	A/D Converter Start Request Timing Double-Buffer Register B	GTADTDBRB	16	16	4, 5 PCLKA	2, 3 ICLK	GPTA
000C 2234h	GPT2	General PWM Timer Output Negate Control Register	GTONCR	16	16	4, 5 PCLKA	2, 3 ICLK	GPTA
000C 2236h	GPT2	General PWM Timer Dead Time Control Register	GTDTCR	16	16	4, 5 PCLKA	2, 3 ICLK	GPTA
000C 2238h	GPT2	General PWM Timer Dead Time Value Register U	GTDVU	16	16	4, 5 PCLKA	2, 3 ICLK	GPTA
000C 223Ah	GPT2	General PWM Timer Dead Time Value Register D	GTDVD	16	16	4, 5 PCLKA	2, 3 ICLK	GPTA
000C 223Ch	GPT2	General PWM Timer Dead Time Buffer Register U	GTDBU	16	16	4, 5 PCLKA	2, 3 ICLK	GPTA
000C 223Eh	GPT2	General PWM Timer Dead Time Buffer Register D	GTDBD	16	16	4, 5 PCLKA	2, 3 ICLK	GPTA
000C 2240h	GPT2	General PWM Timer Output Protection Function Status Register	GTSOS	16	16	4, 5 PCLKA	2, 3 ICLK	GPTA
000C 2242h	GPT2	General PWM Timer Output Protection Function Temporary Release Register	GTSOTR	16	16	4, 5 PCLKA	2, 3 ICLK	GPTA
000C 2280h	GPT3	General PWM Timer I/O Control Register	GTIOR	16	16	4, 5 PCLKA	2, 3 ICLK	GPTA
000C 2282h	GPT3	General PWM Timer Interrupt Output Setting Register	GTINTAD	16	16	4, 5 PCLKA	2, 3 ICLK	GPTA
000C 2284h	GPT3	General PWM Timer Control Register	GTCR	16	16	4, 5 PCLKA	2, 3 ICLK	GPTA
000C 2286h	GPT3	General PWM Timer Buffer Enable Register	GTBER	16	16	4, 5 PCLKA	2, 3 ICLK	GPTA
000C 2288h	GPT3	General PWM Timer Count Direction Register	GTUDC	16	16	4, 5 PCLKA	2, 3 ICLK	GPTA
000C 228Ah	GPT3	General PWM Timer Interrupt and A/D Converter Start Request Skipping Setting Register	GTITC	16	16	4, 5 PCLKA	2, 3 ICLK	GPTA
000C 228Ch	GPT3	General PWM Timer Status Register	GTST	16	16	4, 5 PCLKA	2, 3 ICLK	GPTA
000C 228Eh	GPT3	General PWM Timer Counter	GTCNT	16	16	4, 5 PCLKA	2, 3 ICLK	GPTA
000C 2290h	GPT3	General PWM Timer Compare Capture Register A	GTCCRA	16	16	4, 5 PCLKA	2, 3 ICLK	GPTA
000C 2292h	GPT3	General PWM Timer Compare Capture Register B	GTCCRB	16	16	4, 5 PCLKA	2, 3 ICLK	GPTA
000C 2294h	GPT3	General PWM Timer Compare Capture Register C	GTCCRC	16	16	4, 5 PCLKA	2, 3 ICLK	GPTA
000C 2296h	GPT3	General PWM Timer Compare Capture Register D	GTCCRD	16	16	4, 5 PCLKA	2, 3 ICLK	GPTA
000C 2298h	GPT3	General PWM Timer Compare Capture Register E	GTCCRE	16	16	4, 5 PCLKA	2, 3 ICLK	GPTA

Table 4.1 List of I/O Registers (Address Order) (58 / 67)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access Cycles		Related Function
						ICLK ≥ PCLK	ICLK < PCLK	
000C 4900h	EPTPC 0	PTP-primary Message Destination MAC Address Setting Registers	PPMACRU	32	32	9 to 211 PCLKA	2 to 106 ICLK	EPTPC
000C 4904h	EPTPC 0	PTP-primary Message Destination MAC Address Setting Registers	PPMACRL	32	32	9 to 211 PCLKA	2 to 106 ICLK	EPTPC
000C 4908h	EPTPC 0	PTP-pdelay Message MAC Address Setting Registers	PDMACRU	32	32	9 to 211 PCLKA	2 to 106 ICLK	EPTPC
000C 490Ch	EPTPC 0	PTP-pdelay Message MAC Address Setting Registers	PDMACRL	32	32	9 to 211 PCLKA	2 to 106 ICLK	EPTPC
000C 4910h	EPTPC 0	PTP Message EtherType Setting Register	PETYPER	32	32	9 to 211 PCLKA	2 to 106 ICLK	EPTPC
000C 4920h	EPTPC 0	PTP-primary Message Destination IP Address Setting Register	PPIPR	32	32	9 to 211 PCLKA	2 to 106 ICLK	EPTPC
000C 4924h	EPTPC 0	PTP-pdelay Message Destination IP Address Setting Register	PDIPR	32	32	9 to 211 PCLKA	2 to 106 ICLK	EPTPC
000C 4928h	EPTPC 0	PTP event Message TOS Setting Register	PETOSR	32	32	9 to 211 PCLKA	2 to 106 ICLK	EPTPC
000C 492Ch	EPTPC 0	PTP general Message TOS Setting Register	PGTOSR	32	32	9 to 211 PCLKA	2 to 106 ICLK	EPTPC
000C 4930h	EPTPC 0	PTP-primary Message TTL Setting Register	PPTTLR	32	32	9 to 211 PCLKA	2 to 106 ICLK	EPTPC
000C 4934h	EPTPC 0	PTP-pdelay Message TTL Setting Register	PDTTLR	32	32	9 to 211 PCLKA	2 to 106 ICLK	EPTPC
000C 4938h	EPTPC 0	PTP event Message UDP Destination Port Number Setting Register	PEUDPR	32	32	9 to 211 PCLKA	2 to 106 ICLK	EPTPC
000C 493Ch	EPTPC 0	PTP general Message UDP Destination Port Number Setting Register	PGUDPR	32	32	9 to 211 PCLKA	2 to 106 ICLK	EPTPC
000C 4940h	EPTPC 0	Frame Reception Filter Setting Register	FFLTR	32	32	9 to 211 PCLKA	2 to 106 ICLK	EPTPC
000C 4960h	EPTPC 0	Frame Reception Filter MAC Address 0 Setting Registers	FMAC0RU	32	32	9 to 211 PCLKA	2 to 106 ICLK	EPTPC
000C 4964h	EPTPC 0	Frame Reception Filter MAC Address 0 Setting Registers	FMAC0RL	32	32	9 to 211 PCLKA	2 to 106 ICLK	EPTPC
000C 4968h	EPTPC 0	Frame Reception Filter MAC Address 1 Setting Registers	FMAC1RU	32	32	9 to 211 PCLKA	2 to 106 ICLK	EPTPC
000C 496Ch	EPTPC 0	Frame Reception Filter MAC Address 1 Setting Registers	FMAC1RL	32	32	9 to 211 PCLKA	2 to 106 ICLK	EPTPC
000C 49C0h	EPTPC 0	Asymmetric Delay Setting Register	DASYMRU	32	32	9 to 211 PCLKA	2 to 106 ICLK	EPTPC
000C 49C4h	EPTPC 0	Asymmetric Delay Setting Register	DASYMRL	32	32	9 to 211 PCLKA	2 to 106 ICLK	EPTPC
000C 49C8h	EPTPC 0	Timestamp Latency Setting Register	TSLATR	32	32	9 to 211 PCLKA	2 to 106 ICLK	EPTPC
000C 49CCh	EPTPC 0	SYNFP Operation Setting Register	SYCONFR	32	32	9 to 211 PCLKA	2 to 106 ICLK	EPTPC
000C 49D0h	EPTPC 0	SYNFP Frame Format Setting Register	SYFORMR	32	32	9 to 211 PCLKA	2 to 106 ICLK	EPTPC
000C 49D4h	EPTPC 0	Response Message Reception Timeout Register	RSTOUTR	32	32	9 to 211 PCLKA	2 to 106 ICLK	EPTPC
000C 4C00h	EPTPC 1	SYNFP Status Register	SYSR	32	32	9 to 211 PCLKA	2 to 106 ICLK	EPTPC
000C 4C04h	EPTPC 1	SYNFP Status Notification Permission Register	SYIPR	32	32	9 to 211 PCLKA	2 to 106 ICLK	EPTPC
000C 4C10h	EPTPC 1	SYNFP MAC Address Registers	SYMACRU	32	32	9 to 211 PCLKA	2 to 106 ICLK	EPTPC
000C 4C14h	EPTPC 1	SYNFP MAC Address Registers	SYMACRL	32	32	9 to 211 PCLKA	2 to 106 ICLK	EPTPC
000C 4C1Ch	EPTPC 1	SYNFP Local IP Address Register	SYIPADDRR	32	32	9 to 211 PCLKA	2 to 106 ICLK	EPTPC
000C 4C40h	EPTPC 1	SYNFP Specification Version Setting Register	SYSPVRR	32	32	9 to 211 PCLKA	2 to 106 ICLK	EPTPC
000C 4C44h	EPTPC 1	SYNFP Domain Number Setting Register	SYDOMR	32	32	9 to 211 PCLKA	2 to 106 ICLK	EPTPC

Table 4.1 List of I/O Registers (Address Order) (63 / 67)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access Cycles		Related Function
						ICLK ≥ PCLK	ICLK < PCLK	
000D 042Ah	USBA	D0FIFO Port Control Register	D0FIFOCTR	16	16	(3 + BUSWAIT) PCLKA or more	Rounded up to the nearest integer greater than 1 + (3 + BUSWAIT) × (frequency ratio of ICLK/PCLKB)*5	USBA
000D 042Ch	USBA	D1FIFO Port Select Register	D1FIFOSEL	16	16	(3 + BUSWAIT) PCLKA or more	Rounded up to the nearest integer greater than 1 + (3 + BUSWAIT) × (frequency ratio of ICLK/PCLKB)*5	USBA
000D 042Eh	USBA	D1FIFO Port Control Register	D1FIFOCTR	16	16	(3 + BUSWAIT) PCLKA or more	Rounded up to the nearest integer greater than 1 + (3 + BUSWAIT) × (frequency ratio of ICLK/PCLKB)*5	USBA
000D 0430h	USBA	Interrupt Enable Register 0	INTENB0	16	16	(3 + BUSWAIT) PCLKA or more	Rounded up to the nearest integer greater than 1 + (3 + BUSWAIT) × (frequency ratio of ICLK/PCLKB)*5	USBA
000D 0432h	USBA	Interrupt Enable Register 1	INTENB1	16	16	(3 + BUSWAIT) PCLKA or more	Rounded up to the nearest integer greater than 1 + (3 + BUSWAIT) × (frequency ratio of ICLK/PCLKB)*5	USBA
000D 0436h	USBA	BRDY Interrupt Enable Register	BRDYENB	16	16	(3 + BUSWAIT) PCLKA or more	Rounded up to the nearest integer greater than 1 + (3 + BUSWAIT) × (frequency ratio of ICLK/PCLKB)*5	USBA
000D 0438h	USBA	NRDY Interrupt Enable Register	NRDYENB	16	16	(3 + BUSWAIT) PCLKA or more	Rounded up to the nearest integer greater than 1 + (3 + BUSWAIT) × (frequency ratio of ICLK/PCLKB)*5	USBA
000D 043Ah	USBA	BEMP Interrupt Enable Register	BEMPENB	16	16	(3 + BUSWAIT) PCLKA or more	Rounded up to the nearest integer greater than 1 + (3 + BUSWAIT) × (frequency ratio of ICLK/PCLKB)*5	USBA
000D 043Ch	USBA	SOF Output Configuration Register	SOFCFG	16	16	(3 + BUSWAIT) PCLKA or more	Rounded up to the nearest integer greater than 1 + (3 + BUSWAIT) × (frequency ratio of ICLK/PCLKB)*5	USBA
000D 043Eh	USBA	PHY Setting Register	PHYSET	16	16	(3 + BUSWAIT) PCLKA or more	Rounded up to the nearest integer greater than 1 + (3 + BUSWAIT) × (frequency ratio of ICLK/PCLKB)*5	USBA
000D 0440h	USBA	Interrupt Status Register 0	INTSTS0	16	16	(3 + BUSWAIT) PCLKA or more	Rounded up to the nearest integer greater than 1 + (3 + BUSWAIT) × (frequency ratio of ICLK/PCLKB)*5	USBA
000D 0442h	USBA	Interrupt Status Register 1	INTSTS1	16	16	(3 + BUSWAIT) PCLKA or more	Rounded up to the nearest integer greater than 1 + (3 + BUSWAIT) × (frequency ratio of ICLK/PCLKB)*5	USBA
000D 0446h	USBA	BRDY Interrupt Status Register	BRDYSTS	16	16	(3 + BUSWAIT) PCLKA or more	Rounded up to the nearest integer greater than 1 + (3 + BUSWAIT) × (frequency ratio of ICLK/PCLKB)*5	USBA
000D 0448h	USBA	NRDY Interrupt Status Register	NRDYSTS	16	16	(3 + BUSWAIT) PCLKA or more	Rounded up to the nearest integer greater than 1 + (3 + BUSWAIT) × (frequency ratio of ICLK/PCLKB)*5	USBA
000D 044Ah	USBA	BEMP Interrupt Status Register	BEMPSTS	16	16	(3 + BUSWAIT) PCLKA or more	Rounded up to the nearest integer greater than 1 + (3 + BUSWAIT) × (frequency ratio of ICLK/PCLKB)*5	USBA

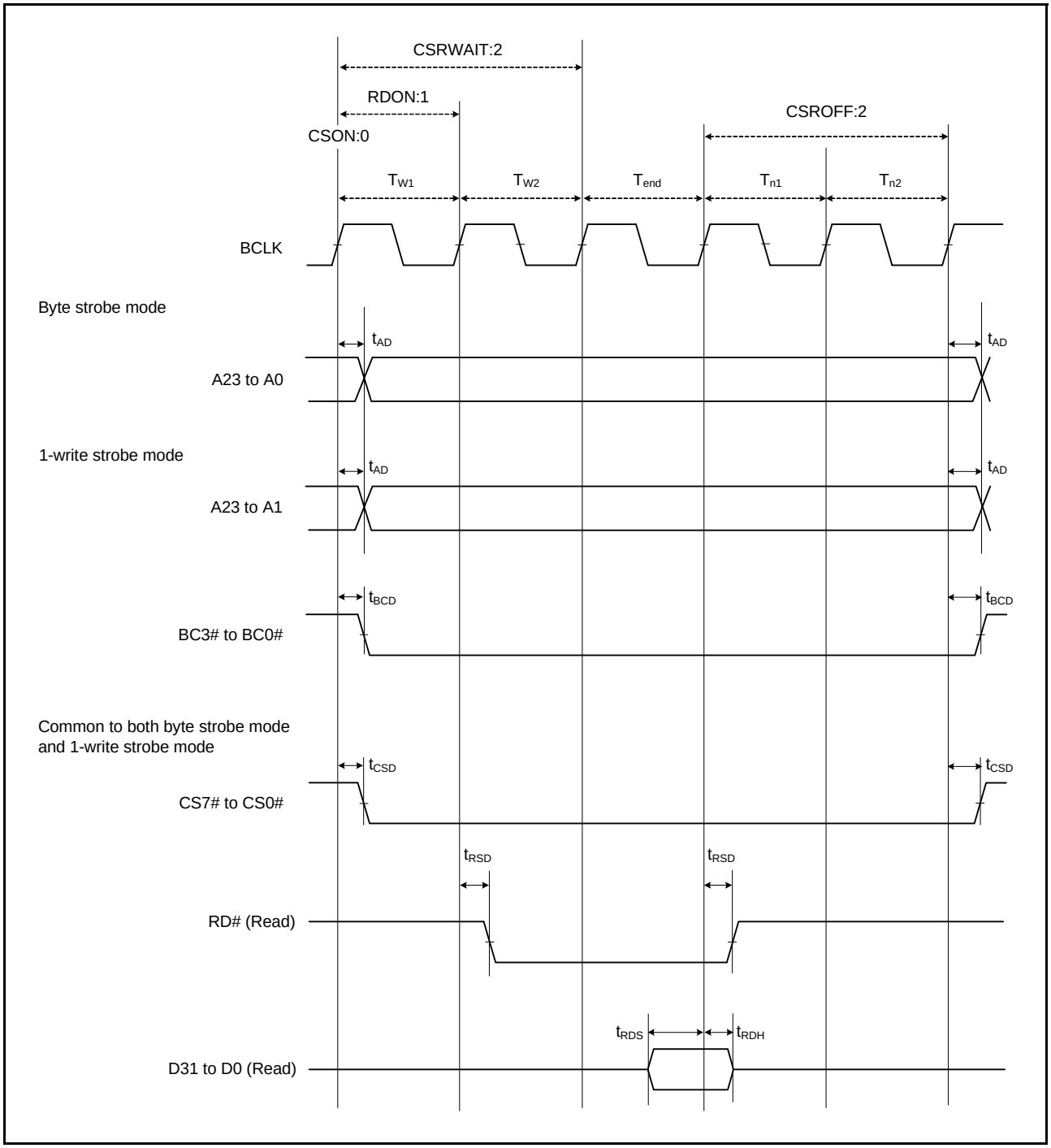


Figure 5.18 External Bus Timing/Normal Read Cycle (Bus Clock Synchronized)

5.3.6 EXDMAC Timing

Table 5.22 EXDMAC Timing

Conditions: VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 to 3.6 V, 2.7 ≤ VREFH0 ≤ AVCC0,
VCC_USBA = AVCC_USBA = 3.0 to 3.6 V,
VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = VSS1_USBA = VSS2_USBA = PVSS_USBA = AVSS_USBA = 0 V,
ICLK = PCLKA = 8 to 120 MHz, PCLKB = BCLK = SDCLK = 8 to 60 MHz, $T_a = T_{opr}$
Output load conditions: V_{OH} = VCC × 0.5, V_{OL} = VCC × 0.5, C = 30 pF
High-drive output is selected by the driving ability control register.

Item		Symbol	Min.	Max.	Unit	Test Conditions
EXDMAC	EDREQ setup time	t_{EDRQS}	13	—	ns	Figure 5.30
	EDREQ hold time	t_{EDRQH}	2	—	ns	
	EDACK delay time	t_{EDACD}	—	13	ns	Figure 5.31, Figure 5.32

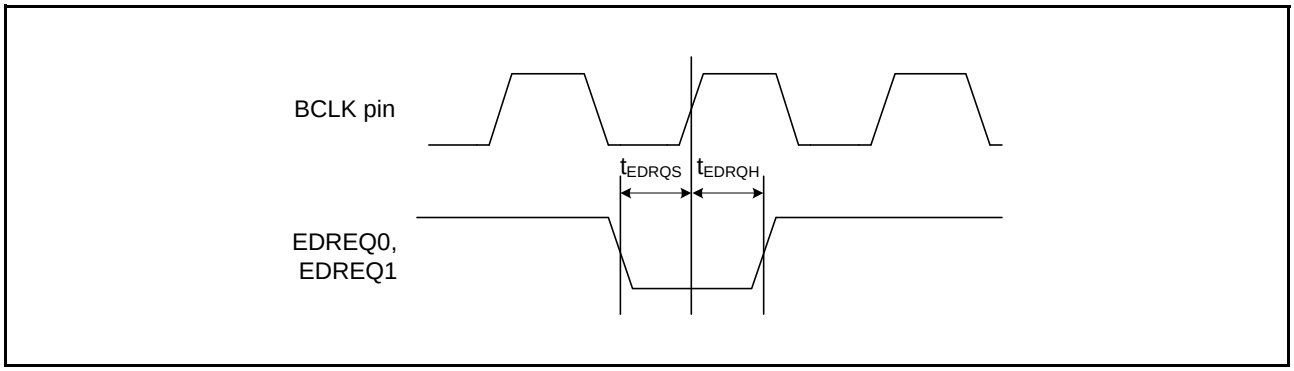


Figure 5.30 EDREQ0 and EDREQ1 Input Timing

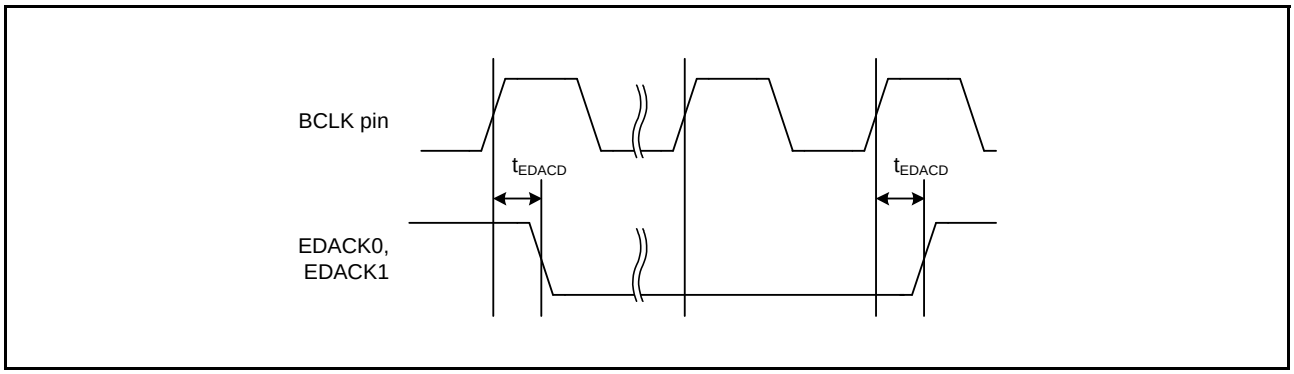


Figure 5.31 EDACK0 and EDACK1 Single-Address Transfer Timing (for a CS Area)

Table 5.27 MTU3 Timing

Conditions: VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 to 3.6 V, 2.7 ≤ VREFH0 ≤ AVCC0,
VCC_USBA = AVCC_USBA = 3.0 to 3.6 V,
VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = VSS1_USBA = VSS2_USBA = PVSS_USBA = AVSS_USBA = 0 V,
PCLKA = 8 to 120 MHz, PCLKB = 8 to 60 MHz, $T_a = T_{opr}$
Output load conditions: V_{OH} = VCC × 0.5, V_{OL} = VCC × 0.5, C = 30 pF
High-drive output is selected by the driving ability control register.

Item			Symbol	Min.	Max.	Unit*1	Test Conditions
MTU3	Input capture input pulse width	Single-edge setting	t_{MTICW}	1.5	—	t_{PAcyc}	Figure 5.38
		Both-edge setting		2.5	—		
	Timer clock pulse width	Single-edge setting	t_{MTCKWH}, t_{MTCKWL}	1.5	—	t_{PAcyc}	Figure 5.39
		Both-edge setting		2.5	—		
		Phase counting mode		2.5	—		

Note 1. t_{PAcyc}: PCLKA cycle

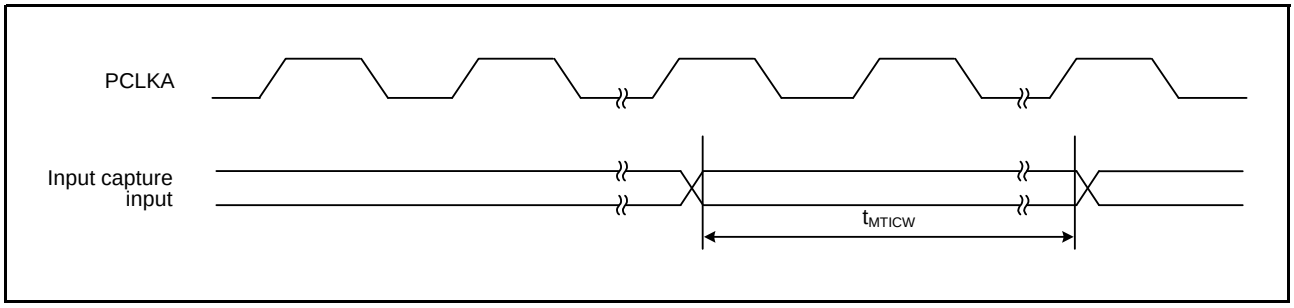


Figure 5.38 MTU3 Input Capture Input Timing

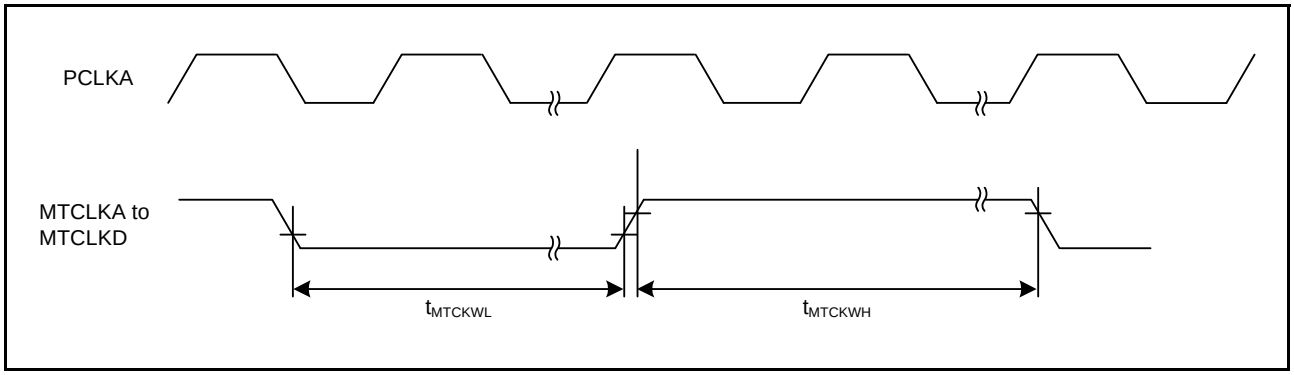


Figure 5.39 MTU3 Clock Input Timing

Table 5.32 SCI and SCIF Timing

Conditions: VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 to 3.6 V, 2.7 ≤ VREFH0 ≤ AVCC0,
VCC_USBA = AVCC_USBA = 3.0 to 3.6 V,
VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = VSS1_USBA = VSS2_USBA = PVSS_USBA = AVSS_USBA = 0 V,
PCLKA = 8 to 120 MHz, PCLKB = 8 to 60 MHz, $T_a = T_{opr}$
Output load conditions: V_{OH} = VCC × 0.5, V_{OL} = VCC × 0.5, C = 30 pF
High-drive output is selected by the driving ability control register.

Item			Symbol	Min.*1	Max.*1	Unit*1	Test Conditions
SCI	Input clock cycle	Asynchronous	t_{Scyc}	4	—	t_{PBcyc}	Figure 5.44
		Clock synchronous		6	—		
	Input clock pulse width		t_{SCKW}	0.4	0.6	t_{Scyc}	
	Input clock rise time		t_{SCKr}	—	5	ns	
	Input clock fall time		t_{SCKf}	—	5	ns	
	Output clock cycle	Asynchronous*2	t_{Scyc}	8	—	t_{PBcyc}	
		Clock synchronous		4	—		
	Output clock pulse width		t_{SCKW}	0.4	0.6	t_{Scyc}	
	Output clock rise time		t_{SCKr}	—	5	ns	
	Output clock fall time		t_{SCKf}	—	5	ns	
	Transmit data delay time	Clock synchronous	t_{TXD}	—	28	ns	Figure 5.45
	Receive data setup time	Clock synchronous	t_{RXS}	15	—	ns	
	Receive data hold time	Clock synchronous	t_{RXH}	5	—	ns	
SCIF	Input clock cycle	Asynchronous	t_{Scyc}	4	—	t_{PAcyc}	Figure 5.44
		Clock synchronous		12	—		
	Input clock pulse width		t_{SCKW}	0.4	0.6	t_{Scyc}	
	Input clock rise time		t_{SCKr}	—	5	ns	
	Input clock fall time		t_{SCKf}	—	5	ns	
	Output clock cycle	Asynchronous*3	t_{Scyc}	8	—	t_{PAcyc}	
		Clock synchronous		4	—		
	Output clock pulse width		t_{SCKW}	0.4	0.6	t_{Scyc}	
	Output clock rise time		t_{SCKr}	—	5	ns	
	Output clock fall time		t_{SCKf}	—	5	ns	
	Transmit data delay time	Master	t_{TXD}	—	10	ns	Figure 5.45
		Slave		—	$4 \times t_{PAcyc} + 20$		
	Receive data setup time	Master	t_{RXS}	$3 \times t_{PAcyc} + 20$	—	ns	
		Slave		$t_{PAcyc} + 10$	—		
	Receive data hold time	Master	t_{RXH}	$-3 \times t_{PAcyc} + 5$	—	ns	
		Slave		$2 \times t_{PAcyc} + 10$	—		

Note 1. t_{PBcyc}: PCLKB cycle; t_{PAcyc}: PCLKA cycle
Note 2. When the SEMR.ABCS and SEMR.BGDM bits are set to 1
Note 3. When the SEMR.ABCS0 and SEMR.BGDM bits are set to 1

Table 5.36 RIIC Timing (1)

Conditions: VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 to 3.6 V, 2.7 ≤ VREFH0 ≤ AVCC0,
VCC_USBA = AVCC_USBA = 3.0 to 3.6 V,
VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = VSS1_USBA = VSS2_USBA = PVSS_USBA = AVSS_USBA = 0 V,
PCLKA = 8 to 120 MHz, PCLKB = 8 to 60 MHz, $T_a = T_{opr}$
High-drive output is selected by the driving ability control register.

Item		Symbol	Min.*1, *2	Max.	Unit	Test Conditions
RIIC (Standard-mode, SMBus) ICFER.FMPE = 0	SCL input cycle time	t_{SCL}	6(12) × t_{IICcyc} + 1300	—	ns	Figure 5.56
	SCL input high pulse width	t_{SCLH}	3(6) × t_{IICcyc} + 300	—	ns	
	SCL input low pulse width	t_{SCLL}	3(6) × t_{IICcyc} + 300	—	ns	
	SCL, SDA input rise time	t_{Sr}	—	1000	ns	
	SCL, SDA input fall time	t_{Sf}	—	300	ns	
	SCL, SDA input spike pulse removal time	t_{SP}	0	1(4) × t_{IICcyc}	ns	
	SDA input bus free time	t_{BUF}	3(6) × t_{IICcyc} + 300	—	ns	
	Start condition input hold time	t_{STAH}	t_{IICcyc} + 300	—	ns	
	Restart condition input setup time	t_{STAS}	1000	—	ns	
	Stop condition input setup time	t_{STOS}	1000	—	ns	
	Data input setup time	t_{SDAS}	t_{IICcyc} + 50	—	ns	
	Data input hold time	t_{SDAH}	0	—	ns	
	SCL, SDA capacitive load	C_b	—	400	pF	
RIIC (Fast-mode) ICFER.FMPE = 0	SCL input cycle time	t_{SCL}	6(12) × t_{IICcyc} + 600	—	ns	
	SCL input high pulse width	t_{SCLH}	3(6) × t_{IICcyc} + 300	—	ns	
	SCL input low pulse width	t_{SCLL}	3(6) × t_{IICcyc} + 300	—	ns	
	SCL, SDA input rise time	t_{Sr}	20 × (External pull-up voltage/5.5V)	300	ns	
	SCL, SDA input fall time	t_{Sf}	20 × (External pull-up voltage/5.5V)	300	ns	
	SCL, SDA input spike pulse removal time	t_{SP}	0	1(4) × t_{IICcyc}	ns	
	SDA input bus free time	t_{BUF}	3(6) × t_{IICcyc} + 300	—	ns	
	Start condition input hold time	t_{STAH}	t_{IICcyc} + 300	—	ns	
	Restart condition input setup time	t_{STAS}	300	—	ns	
	Stop condition input setup time	t_{STOS}	300	—	ns	
	Data input setup time	t_{SDAS}	t_{IICcyc} + 50	—	ns	
	Data input hold time	t_{SDAH}	0	—	ns	
	SCL, SDA capacitive load	C_b	—	400	pF	

Note: t_{IICcyc}: RIIC internal reference clock (IICϕ) cycle
Note 1. The value within parentheses is applicable when the value of the ICMR3.NF[1:0] bits is 11b while the digital filter is enabled by the setting ICFER.NFE = 1.
Note 2. Cb is the total capacitance of the bus lines.

5.4 USB Characteristics

Table 5.42 On-Chip USB Low Speed (Host Only) Characteristics (DP and DM Pin Characteristics)

Conditions: VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 3.0 to 3.6 V, 3.0 ≤ VREFH0 ≤ AVCC0,
VCC_USBA = AVCC_USBA = 3.0 to 3.6 V,
VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = VSS1_USBA = VSS2_USBA = PVSS_USBA = AVSS_USBA = 0 V,
USBA_RREF = 2.2 kΩ ±1%, USBMCLK = 20/24 MHz, UCLK = 48 MHz,
PCLKA = 8 to 120 MHz, PCLKB = 8 to 60 MHz, $T_a = T_{opr}$

Item		Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Input characteristics	Input high level voltage	V_{IH}	2.0	—	—	V	
	Input low level voltage	V_{IL}	—	—	0.8	V	
	Differential input sensitivity	V_{DI}	0.2	—	—	V	| DP – DM |
	Differential common mode range	V_{CM}	0.8	—	2.5	V	
Output characteristics	Output high level voltage	V_{OH}	2.8	—	3.6	V	I_{OH} = –200 µA
	Output low level voltage	V_{OL}	0.0	—	0.3	V	I_{OL} = 2 mA
	Cross-over voltage	V_{CRS}	1.3	—	2.0	V	Figure 5.75
	Rise time	t_{LR}	75	—	300	ns	
	Fall time	t_{LF}	75	—	300	ns	
	Rise/fall time ratio	t_{LR} / t_{LF}	80	—	125	%	t_{LR}/ t_{LF}
Pull-down characteristics	DP/DM pull-down resistance (when the host controller function is selected)	R_{pd}	14.25	—	24.80	kΩ	

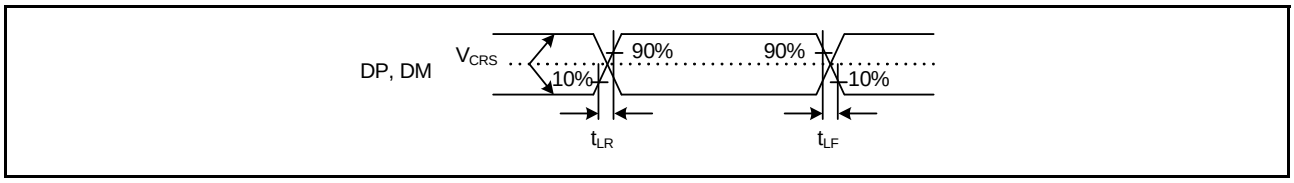


Figure 5.75 DP and DM Output Timing (Low Speed)

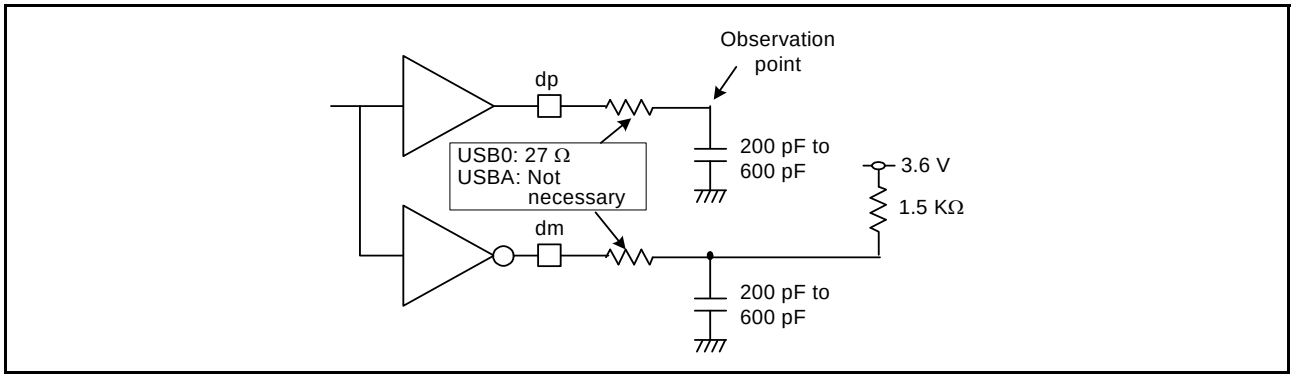


Figure 5.76 Test Circuit (Low Speed)

5.11 Flash Memory Characteristics

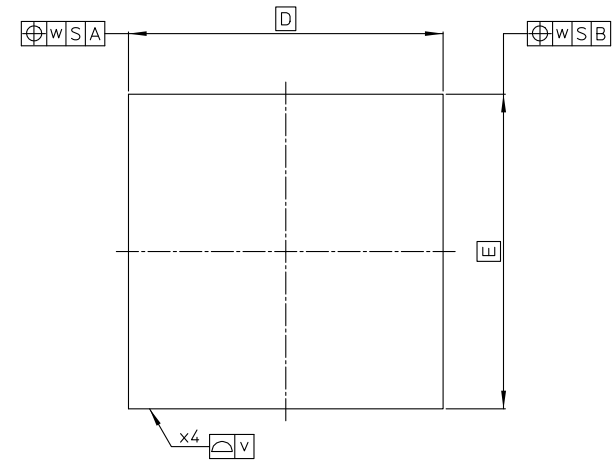
Table 5.53 Code Flash Memory Characteristics

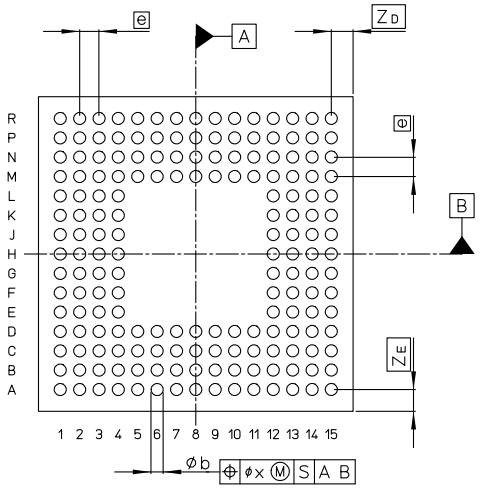
Conditions: VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 to 3.6 V, 2.7 ≤ VREFH0 ≤ AVCC0,
VCC_USBA = AVCC_USBA = 3.0 to 3.6 V,
VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = VSS1_USBA = VSS2_USBA = PVSS_USBA = AVSS_USBA = 0 V
Temperature range for programming/erasure: $T_a = T_{opr}$

Item		Symbol	FCLK = 4 MHz			20 MHz ≤ FCLK ≤ 60 MHz			Unit
			Min.	Typ.	Max.	Min.	Typ.	Max.	
Programming time N_{PEC} ≤ 100 times	256 bytes	t_{P256}	—	0.9	13.2	—	0.4	6	ms
	8 Kbytes	t_{P8K}	—	29	176	—	13	80	ms
	32 Kbytes	t_{P32K}	—	116	704	—	52	320	ms
Programming time N_{PEC} > 100 times	256 bytes	t_{P256}	—	1.1	15.8	—	0.5	7.2	ms
	8 Kbytes	t_{P8K}	—	35	212	—	16	96	ms
	32 Kbytes	t_{P32K}	—	140	848	—	64	384	ms
Erasure time N_{PEC} ≤ 100 times	8 Kbytes	t_{E8K}	—	71	216	—	39	120	ms
	32 Kbytes	t_{E32K}	—	254	864	—	141	480	ms
Erasure time N_{PEC} > 100 times	8 Kbytes	t_{E8K}	—	85	260	—	47	144	ms
	32 Kbytes	t_{E32K}	—	304	1040	—	169	576	ms
Reprogramming/erasure cycle*1		N_{PEC}	1000*2	—	—	1000*2	—	—	Times
Suspend delay time during programming		t_{SPD}	—	—	264	—	—	120	µs
First suspend delay time during erasing (in suspend priority mode)		t_{SESD1}	—	—	216	—	—	120	µs
Second suspend delay time during erasure (in suspend priority mode)		t_{SESD2}	—	—	1.7	—	—	1.7	ms
Suspend delay time during erasure (in erasure priority mode)		t_{SEED}	—	—	1.7	—	—	1.7	ms
Forced stop command		t_{FD}	—	—	32	—	—	20	µs
Data hold time*3		t_{DRP}	10	—	—	10	—	—	Year
FCU reset time		t_{FCUR}	35	—	—	35	—	—	µs

Note 1. Definition of reprogram/erase cycle:
The reprogram/erase cycle is the number of erasing for each block. When the reprogram/erase cycle is n times (n = 1000), erasing can be performed n times for each block. For instance, when 256-byte programming is performed 32 times for different addresses in 8-Kbyte block and then the entire block is erased, the reprogram/erase cycle is counted as one. However, programming the same address for several times as one erasing is not enabled (overwriting is prohibited).
Note 2. This is the minimum number of times to guarantee all the characteristics after reprogramming (guaranteed range is from 1 to the value of the minimum value).
Note 3. This shows the characteristics when reprogramming is performed within the specified range, including the minimum value.

JEITA Package Code	RENESAS Code	Previous Code	MASS[Typ.]
P-LFBGA176-13x13-0.80	PLBG0176GA-A	BP-176/BP-176V	0.45g

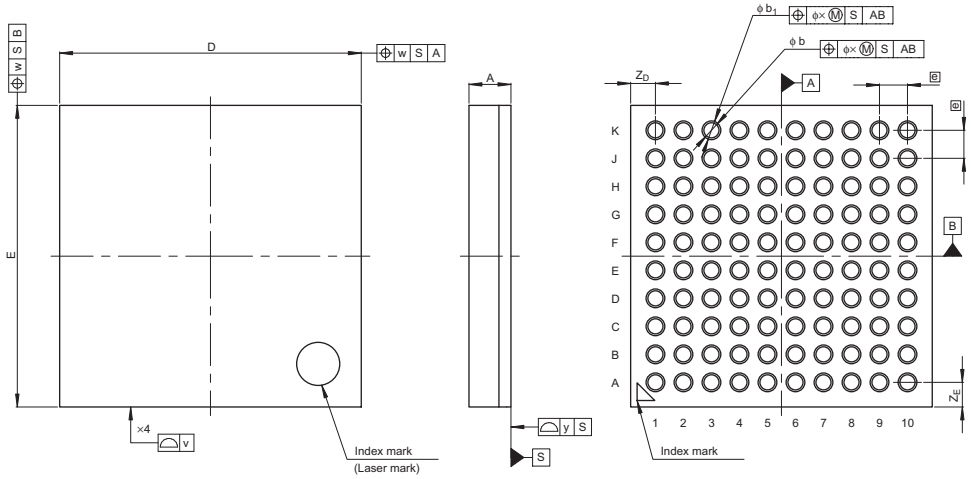




Reference Symbol	Dimension in Millimeters		
	Min	Nom	Max
D	—	13.0	—
E	—	13.0	—
v	—	—	0.15
w	—	—	0.20
A	—	—	1.40
A_1	0.35	0.40	0.45
e	—	0.80	—
b	0.45	0.50	0.55
x	—	—	0.08
y	—	—	0.10
y_1	—	—	0.2
S_D	—	—	—
S_E	—	—	—
Z_D	—	0.90	—
Z_E	—	0.90	—

Figure B 176-Pin LFBGA (PLBG0176GA-A)

JEITA Package Code	RENESAS Code	Previous Code	MASS[Typ.]
P-TFLGA100-7x7-0.65	PTLG0100JA-A	100F0G	0.1g



Reference Symbol	Dimension in Millimeters		
	Min	Nom	Max
D	—	7.0	—
E	—	7.0	—
v	—	—	0.15
w	—	—	0.20
A	—	—	1.05
e	—	0.65	—
b	0.31	0.35	0.39
b_1	0.385	0.435	0.485
x	—	—	0.08
y	—	—	0.10
Z_D	—	0.575	—
Z_E	—	0.575	—

Figure F 100-Pin TFLGA (PTLG0100JA-A)

Rev.	Date	Description		Classification
		Page	Summary	
1.10	Oct 24, 2016	108	Table 4.1 List of I/O Registers (Address Order) (37 / 67) 0008 C296h, added	
		110	Table 4.1 List of I/O Registers (Address Order) (39 / 67), changed	TN-RX*-A152A/E
		111	Table 4.1 List of I/O Registers (Address Order) (40 / 67), changed	
		112	Table 4.1 List of I/O Registers (Address Order) (41 / 67), changed	
		119	Table 4.1 List of I/O Registers (Address Order) (48 / 67) 000C 0438h, 000C 046Ch, deleted	
		132, 133	Table 4.1 List of I/O Registers (Address Order) (61 / 67), (62 / 67), changed	
		138	Table 4.1 List of I/O Registers (Address Order), Note 6 added	TN-RX*-A152A/E
		5. Electrical Characteristics		
		139	Table 5.1 Absolute Maximum Rating, changed	TN-RX*-A160A/E
		140	Table 5.2 DC Characteristics (1), changed	TN-RX*-A159A/E TN-RX*-A160A/E
		141	Table 5.3 DC Characteristics (2), changed	TN-RX*-A159A/E
		183	Figure 5.48 RSPI Timing (Master, CPHA = 0) (Bit Rate: PCLKB Division Ratio Set to 1/2), changed	
		206	Table 5.49 Temperature Sensor Characteristics, changed	TN-RX*-A159A/E
		212	Figure 5.84 Battery Backup Function Characteristics, changed	
		213	Table 5.53 Code Flash Memory Characteristics, changed	TN-RX*-A146A/E
		214	Table 5.54 Data Flash Memory Characteristics, changed	